

NOTE: This disposition is nonprecedential.

**United States Court of Appeals  
for the Federal Circuit**

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**DANIEL L. FLAMM,**  
*Appellant*

v.

**MICRON TECHNOLOGY, INC., INTEL  
CORPORATION, GLOBALFOUNDRIES U.S., INC.,  
SAMSUNG ELECTRONICS COMPANY, LTD.,**  
*Appellees*

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2018-2322

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Appeal from the United States Patent and Trademark  
Office, Patent Trial and Appeal Board in Nos. IPR2017-  
00391, IPR2017-01746.

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**JUDGMENT**

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ROLF STADHEIM, Stadheim & Grear, Scottsdale, AZ, ar-  
gued for appellant.

MELANIE L. BOSTWICK, Orrick, Herrington & Sutcliffe  
LLP, Washington, DC, argued for appellees Micron Tech-  
nology, Inc., Intel Corporation, GLOBALFOUNDRIES  
U.S., Inc. Appellee Micron Technology, Inc. also repre-  
sented by JARED BOBROW, JEREMY JASON LANG, Menlo

Park, CA.

CHAD S. CAMPBELL, Perkins Coie LLP, Phoenix, AZ, for appellee Intel Corporation. Also represented by TYLER R. BOWEN; DAN L. BAGATELL, Hanover, NH; PHILIP ALCIDE MORIN, San Diego, CA; JONATHAN L. MCFARLAND, Seattle, WA.

SHAMITA ETIENNE-CUMMINGS, White & Case LLP, Washington, DC, for appellee GLOBALFOUNDRIES U.S., Inc. Also represented by DAVID TENNANT.

NAVEEN MODI, Paul Hastings LLP, Washington, DC, for appellee Samsung Electronics Company, Ltd.

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THIS CAUSE having been heard and considered, it is

ORDERED and ADJUDGED:

PER CURIAM (PROST, *Chief Judge*, PLAGER and STOLL, *Circuit Judges*).

**AFFIRMED. See Fed. Cir. R. 36.**

ENTERED BY ORDER OF THE COURT

September 6, 2019

Date

/s /Peter R. Marksteiner

Peter R. Marksteiner  
Clerk of Court